

TLE984xQX

Application Hints

About this document

Scope and purpose

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

This Application Note is intended to provide helpful suggestions and hints how to set up and handle specific modules and functionalities which are not subject of the Users Manual or Data Sheet and might be interesting for end users. It is organized in a frequently asked question style and doesn't follow any specific order.

Intended audience

This template is intended for Customer and FAE to document frequently asked question and answers for the embedded Power IC, TLE984xQX device family.

Table of Contents

	About this document	1
	Table of Contents	2
1	Introduction	3
2	Collection of Topics	4
2.1	GPIO Port Map and Alternate Functions	4
2.1.1	GPIO Register description	4
2.1.2	Alternate Function configuration example	4
2.1.3	Port Map implementation of Alternate Functions	5
3	Revision History	6

1 Introduction

This Application Note lists topics which emerged from frequently asked questions of users or from changed user requirements. Each topic is organized in three sections:

- **Topic:**
 - Short description of the issue.
- **Description:**
 - More details about the topic
- **Implementation hint (optional):**
 - Instruction how to handle this topic

2 Collection of Topics

2.1 GPIO Port Map and Alternate Functions

Topic:

What GPIO is connected to which module of the chip.

Description:

The TLE984xQX has 18 port pins organized in three parallel ports: Port 0 (P0), Port 1 (P1) and Port 2 (P2). Each port pin has a pair of internal pull-up and pull-down devices that can be individually enabled or disabled. Either pull-up or pull-down devices can be enabled at a time, for a single port pin. P0 and P1 are bidirectional and can be used as general purpose input/output (GPIO) or to perform alternate input/output functions for the on-chip peripherals. When configured as an output, the open drain mode can be selected. On Port 2 (P2) analog inputs are shared with general purpose input.

2.1.1 GPIO Register description

Each port consists of 8-bit control and data registers. The registers are defined in [Table 1](#).

Table 1 Port Register

Register Short Name	Register Long Name	Description
Px_DATA	Port x Data Register	x = {0,1,2}
Px_DIR	Port x Direction Register	x = {0,1,2}
Px_OD	Port x Open Drain Control Register	x = {0,1,2}
Px_PUDSEL	Port x Pull-Up/Pull-Down Select Register	x = {0,1,2}
Px_PUDEN	Port x Pull-Up/Pull-Down Enable Register	x = {0,1,2}
Px_ALTSEL0	Port x Alternate Select Register 0	x = {0,1,2}
Px_ALTSEL1	Port x Alternate Select Register 1	x = {0,1,2}

2.1.2 Alternate Function configuration example

The ports P0 and P1 can be configured to four different output functions. The default configuration is the GPIO function. The three remaining functions are alternate output functions.

The alternate output function selection is splitted in two bitfields (e.g. **P1_ALTSEL0** and **P1_ALTSEL1**).

ALTSEL1 contains the most significant bit. **ALTSEL0** contains the least significant bit. The given example code shows how to configure these bitfields to connect UART2 module (TXD, RXD) with the GPIOs (P1.0, P1.1).

```

/* connect UART2 to GPIO */
/* set P1.0 to UART2_TXD: */
PORT->P1_DIR.bit.PP0 = 1u; /* PORT P1.0 output configuration */
PORT->P1_ALTSEL0.bit.PP0 = 1u; /* UART2_TXD alternate function 3 */
PORT->P1_ALTSEL1.bit.PP0 = 1u; /* UART2_TXD alternate function 3 */
/* Set P1.1 to UART2_RXD: */
PORT->P1_DIR.bit.PP1 = 0u; /* PORT P1.1 input configuration */

```

Collection of Topics

2.1.3 Port Map implementation of Alternate Functions

Graphical Portmap of Alternate Functions

Each pin is able to handle multiple purposes. **Figure 1** shows the internal signals mapped to GPIOs. The arrow boxes contain the signal names and indicate the data flow direction.

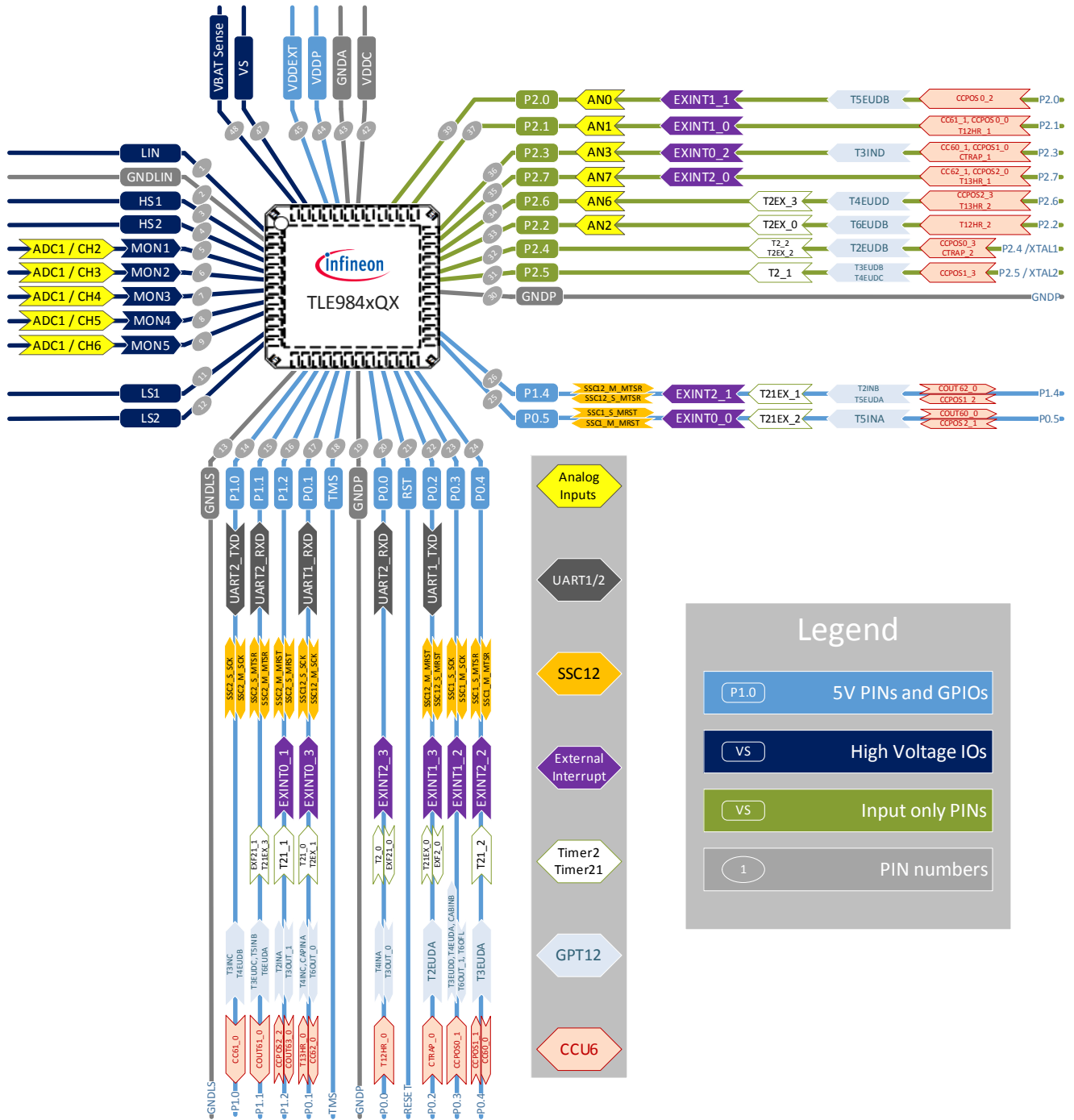


Figure 1 Port Map of Alternate Functions

Revision History

3 Revision History

Revision	Date	Changes
1.0	2016-09-29	Release state

Trademarks of Infineon Technologies AG

μ HVIC™, μ IPM™, μ PFC™, AU-ConvertIR™, AURIX™, C166™, CanPAK™, CIPOS™, CIPURSE™, CoolDP™, CoolGaN™, COOLiR™, CoolMOS™, CoolSET™, CoolSiC™, DAVE™, DI-POL™, DirectFET™, DrBlade™, EasyPIM™, EconoBRIDGE™, EconoDUAL™, EconoPACK™, EconoPIM™, EiceDRIVER™, eupec™, FCOS™, GaNpowIR™, HEXFET™, HITFET™, HybridPACK™, iMOTION™, IRAM™, ISOFACE™, IsoPACK™, LEDriviR™, LITIX™, MIPAQ™, ModSTACK™, my-d™, NovalithIC™, OPTIGA™, OptiMOS™, ORIGA™, PowIRaudio™, PowIRstage™, PrimePACK™, PrimeSTACK™, PROFET™, PRO-SIL™, RASIC™, REAL3™, SmartLEWIS™, SOLID FLASH™, SPOC™, StrongIRFET™, SupIRBuck™, TEMPFET™, TRENCHSTOP™, TriCore™, UHVIC™, XHP™, XMC™.

Trademarks updated November 2015

Other Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2016-09-29

Published by

Infineon Technologies AG

81726 Munich, Germany

© 2016 Infineon Technologies AG.

All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference

<Doc_Number>

IMPORTANT NOTICE

The information contained in this application note is given as a hint for the implementation of the product only and shall in no event be regarded as a description or warranty of a certain functionality, condition or quality of the product. Before implementation of the product, the recipient of this application note must verify any function and other technical information given herein in the real application. Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind (including without limitation warranties of non-infringement of intellectual property rights of any third party) with respect to any and all information given in this application note.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.